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Solution Processed AZO Thin Films Prepared from Different Source Materials

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Aluminum doped Zinc Oxide films were spin-coated from 1 mol% doped precursors obtained from different source materials optimizing post-deposition annealing in controlled atmospheres. AZO films were provided with pre-deposition heating at 500 °C in ambient while post-deposition rapid thermal annealing (RTA) in vacuum and in N_2 -5%H $_2$ was provided at 400, 500 and 600 °C. Dominant ZnO c-axis oriented AZO films with typical wurtzite crystal structure were obtained. Aluminum nitrate source materials resulted in comparatively higher conductivity AZO films. We conclude post-deposition annealing in controlled environments helped increase oxygen vacancies and enhanced grain growth and crystallinity resulting in increased conductivity. Optical measurements showed an average total transmittance (%T) of about 85 % in the visible for all the films with a direct allowed band gap of about 3.2.

Keywords: AZO, Solution synthesis, Spin coating, Rapid thermal annealing, Transparent conducting oxides

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1. INTRODUCTION

Transparent metal oxides and thin conducting films 65 are an integral part of nowadays display and touch-66 screen applications. Indium Tin Oxide (ITO), thanks to 67 its low resistivity, high optical transparency and chem-68 ical stability, holds stronger the transparent conduct-69 ing oxide (TCO) market. The increasing industry de-70 mands, coupled with scarce indium element resources, 71 compel to look for alternatives. Zinc oxide (ZnO) has 72 been looked at as an alternative and is being investi-73 gated by researched community [1]. ZnO, an otherwise 74 insulator in its perfect crystal form, is an n-type semi-75 conducting compound due to non-stoichiometry of in-76 trinsic defects of oxygen vacancy and zinc interstitials.77 The stability of intrinsic ZnO, along with enhanced78 conductivity is achieved by adding elements which act 79 as donors that replace the Zn atoms and increase free 80 electron density, carrier concentration, or both [2].81 Even the dopants, they give stability to films at high82 temperatures [3-4], and among different dopants,83 Al:ZnO, is of greater interest because of the wide avail-84 ability, for the ease of doping and for the variety of 85 preparation techniques & processes [4-7]. In this work 86 we report on AZO thin films, prepared through solution87 synthesis, that avoid the complexities of the vacuum88 equipment. AZO films were prepared from precursors89 obtained using different dopant sources for aluminum.90 A post-deposition thermal treatment, RTA, under vac-91 uum and under N₂-5%H₂ atmosphere for 10 minutes 92 each at 400, 500 and 600 °C temperatures was provid-93 ed. Aluminum nitrate sources along with RTA has been 94 found to be very effective in giving higher conductivity95 with required optical transparency to films in compara-96

tively short times of application keeping the thicknesses comparatively lower.

2. EXPERIMENTAL DETAILS

Zinc acetate dehydrate (Zn(CH₃CO₂)_{2.2}H₂O, trace metal basis, 99.999%) was used as a starting material with 2-methoxyethanol (CH₃O(CH₂)₂OH, anhydrous, 99.8%) (2-MEA) as solvent and mono-ethanolamine ((HOC₂H₄)NH₂, min. 99%) (MEA) (99% min) as stabilizer. Aluminum chloride hexahydrate (AlCl3.6H2O, anhydrous, powder, 99.999%, trace metal basis) and aluminum nitrate nonahydrate (AIN $_3O_{9.9}H_2O$, anhydrous, powder, 99.999%, trace metal basis) in 1 mol% were used as dopants. All ingredients were used as purchased from Sigma Aldrich. The starting material was dissolved in solvent, at 0.35 M concentration, and the MEA was added in molar ratio of 1:1. Solutions were stirred at 60 °C for 2 hours to obtain clear and homogeneous solutions and were brought to room temperature and aged for 2 days. Solutions were stirred again at 60 °C for 10 minutes and cooled to room temperature before deposition of films. Corning glass substrates were cleaned in an ultrasonic bath at 60°C first in acetone and then in 2-isopropanol, each for 15 minutes. After drying with N₂, substrates received a 30 minutes UV/Ozone surface activation step in a PSD-UV Novascan system. Individual layers were spin coated at 3000 rpm for 30 seconds. Successive layers received pre-deposition consolidation heating at 500°C for 10 minutes. Post-deposition RTA was provided in vacuum and then in N2-5%H2 environment at 400, 500, and 600 °C for 10 minutes each to whole of film stacks.

Electrical resistance of thin films was first assessed

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first by measuring the sheet resistance using four-point 56 probe method with a Jandel Engineering, UK instru-57 ment and then calculating the resistivity by the formu-58 la $\rho = V/I \times t$, where "t" refers to the thickness of film59 and "V" is the voltage drop across the sample at the60 applied current "I". Hall Effect measurements were61 carried out using HL555 LN2 CRYOSTAT system by62 Nanometrics to know in detail bulk resistivity, carrier63 concentration and mobility. The films were character-64 ized by optical transparency in the visible using a Per-65 kin Elmer Lambda 950 UV/VIS/NIR Spectrophotome-66 ter. Thickness of AZO films was measured using Ambi-67 os XP-200 Profilometer. The structure of films was ob-68 served by X-ray diffraction (XRD).

3. RESULTS AND DISCUSSIONS

Films intended for application as TCO are mainly 73 characterized for electrical resistivity and optical 74 transparency. Increased thickness could potentially 75 result in low electrical resistivity films, but transparen-76 cy would be then compromised. While very thin films 77 are optically transparent but have higher resistivity. 78 Here we report results for films which possess required 79 conductivity with desired optical transparency in the 80 visible. Comparable results vis-à-vis electrical conduc-81 tivity and optical transparency were achieved keeping 82 the thickness, amount of source materials, annealing 83 temperatures and annealing time comparatively lower 84 than those reported in literature for films prepared 85 through solution synthesis [8-17].

3.1 XRD structural analysis

XRD analysis was carried out in the 2θ range of $0^{\circ}_{90}^{89}$ to 80° to determine physical structure and level of crys- $_{91}$ tallinity of prepared films using Panalytical X'Pert $_{92}$ PRO diffractometer in Bragg-Brentano (θ /2 θ coupled) $_{93}$ geometry with Cu K_{α} line radiation (λ = 1.540598 Å). $_{94}$ Fig. 1 shows diffraction peaks in case of films of both $_{95}$ dopants. All the films irrespective of the dopant and $_{96}$ pre- and post-deposition annealing were found strongly $_{97}$ $_{c}$ -axis oriented with characteristic ZnO hexagonal $_{98}$ wurtzite structure and diffraction peak of crystal orien- $_{99}$ tation (002) appearing at about 34.5° due to self $_{100}$ texturing phenomena [18].

For both the dopants, only characteristic zinc oxide $_{02}$ diffraction peaks appeared with very much increased $_{03}$ intensity [19] in contrast to other examples [20] where $_{04}$ other peaks appeared as well. This shows that RTA $_{105}$

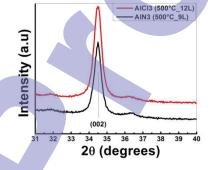


Fig. 1 – Diffraction peaks for the films of both dopants

post-deposition depress the growth of other peaks [21] and increases the growth of the characteristic peak. Also smaller width of the peak of AlN₃O₉.9H₂O dopant solution in comparison to films from AICI₃.6H₂O dopant solution indicates increased grain growth with a monocrystalline character of these films. This tendered higher mobility to charge carriers and eventually reduced resistivity in case of AIN₃O_{9.9}H₂O doped films as shown and described in sect. 3.2. We ascribe this enhanced crystallinity to the post-deposition double RTA treatment which helped enhance diffusion of dopants into the ZnO structure and increased densification of grains as is clear in SEM (sect. 3.4) analysis. This resulted in decreased porosity in the films and increased mobility of carriers. These factors were more prominent in case of AIN₃O_{9.9}H₂O doped AZO films. All these factors helped to decrease resistivity of the films.

3.2 Electrical measurements

The electrical resistance of the films, were first checked by a commercial multi-meter, and the ones that show, reasonable value, are better characterized by four-point method. Resistivity values were then calculated multiplying the sheet resistance by thickness of the films. To complement the measurements and confirm the resistivity values, Hall Effect electrical measurements were done to know in detail the electrical behavior of the AZO films treated with RTA temperatures in different controlled environments after preparation. Table 1 presents bulk resistivity, Hall mobility and carrier concentration in case of films with AICI_{3.6}H₂O & AIN₃O_{9.9}H₂O as dopants respectively. Films were given double RTA treatment in controlled environments, first in vacuum and then in N2-5%H2. Thickness of the films from AICI3.6H2O precursor solutions was almost double (220 nm) in comparison to films of AIN₃O_{9.9}H₂O (120 nm) precursors. This higher amount of material provided more than double the charge carrier concentration in the AICI_{3.6}H₂O precursor solution films. This higher carrier concentration however hindered the growth of grains and increased grain boundary area for AICI_{3.6}H₂O precursor solution films. This also increased scattering events in case of AICI_{3.6}H₂O precursor solution films. Hence reduced their mobility. In comparison charge carrier concentrations remained lower for AIN₃O_{9.9}H₂O precursor solution films which reduced scattering events. This is the reason mobility of the charge carriers remained double for films from AIN₃O_{9.9}H₂O precursor solution. This is in confirmation with the results showed by XRD analysis in sect. 3.1. RTA treatment resulted in grain growth & densification of the films. Comparatively bigger grains in case of AIN3O9.9H2 films resulted in reduced area of grain boundaries and hence reduced scattering. We argue that this helped increase mobility for AIN₃O_{9.9}H₂ precursor solution films. This helped to achieve higher conductivity for these AICI_{3.6}H₂O precursor solution films. On the other hand, carrier concentration in the range of 1019 cm-3 was achieved at half thickness for films of AIN₃O_{9.9}H₂ dopant. This helped to reduce amount of material consumption. Films of both dopant sources however showed n-type conductivity.

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Table 1 – Resistivity, Hall mobility and carrier concentrations values for the two types of films

AICI _{3.6} H ₂ O doped films (220 nm)			AIN ₃ O _{9.9} H ₂ O doped films (120 nm)		
Resistivity (Ω·cm)	Hall Mobility (cm ² /V-s)	Concentration (cm - 3)	Resistivity (Ω·cm)	Hall Mobility (cm ² /V-s)	Concentration (cm - 3)
3.710 - 3	4.07	- 9.120·10 ¹⁹	3.02-10-3	10.7	- 4.232·10 ¹⁹

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3.3 Optical measurements

The films received similar pre- and post-deposition 37 annealing treatments in ambient and in controlled at-38 mospheres. The stacks were developed by successive 39 single layer deposition. The films of both dopants however contained different number of layers so varied in 41 thickness. Thickness of AICI₃.6H₂O films was 220 nm 42 while the thickness was 120 nm for AIN₃O₉.9H₂. Total 43 optical transmission remained more than 80% for both 44 films. Optical transmission obtained for both films are 45 reported in Fig. 2. As charge carrier concentration increased, their mobility decreased as measured in electrical characterizations given in section 3.2. Higher carrier concentration with reduced mobility enhanced 49 carrier scattering events and reduced transmission

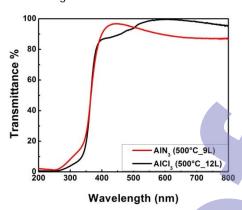


Fig.2 – Optical transmittance in case of films of both dopant 66 solutions

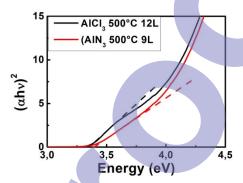


Fig. 3 – Energy band gaps as calculated from Tauc's plot for 81 films of both the dopants

whereas higher mobility with lower carrier concentration reduced scattering events and helped increase
transmission. However increased grain size due to high
annealing temperatures as observed in XRD analysis

when became comparable or larger than light wavelength resulted in diffusion of light and reduced transmittance for films.

Oscillations in transmitted light are generated from interfaces by multiple reflections at the upper and lower interfaces of oxide films as a function of wavelength. The decrease in transmission at lower wavelengths is ascribed to optical band to band absorptions [22]. The absorption edge was calculated in Tauc plot as $(\alpha h v)^2$ vs. hv for the direct allowed transition for both the films and remained a little more than 3.0 eV which is typical value for semiconducting materials.

4. CONCLUSION

In this work two group of films were prepared. The films of group 1 were prepared from precursor solution with AIN₃O_{9.9}H₂ as dopant and while films of group 2 were prepared from precursor solutions of AICI_{3.6}H₂O as dopant. As pure ZnO carries oxygen vacancies and zinc interstitials as charge carriers, more of the carriers generated in case of AICI_{3.6}H₂O dopant. However, mobility was more than double in case of AIN₃O_{9.9}H₂ films. Use of AIN₃O_{9.9}H₂ source material proved advantageous providing better conducting films at lower thicknesses reducing use of precursor materials. Rapid thermal annealing proved its efficacy in enhancing densification of films and increasing grain sizes hence reduction in resistivity. The spread out of heat in furnace tube lowers the effectiveness of the heating method. This is the reason that in case of furnace tube, longer times of annealing are normally required. RTA on the other hand, with its "direct" heating helps lower the time of application. Controlled atmospheres in the case of RTA also reduce possibility of contamination which adds to its usefulness to obtain compact thin films with high transparency & low resistivity. Better conductivity and transparent films were obtained with application of RTA for lower times of application.

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